Ballistic transport enhanced heat convection at nanoscale hotspots

Cite as: J. Appl. Phys. 136, 164306 (2024); doi: 10.1063/5.0221352 Submitted: 31 May 2024 · Accepted: 12 October 2024 · Published Online: 28 October 2024



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Note: This paper is part of the special topic, Thermal Transport in 2D Materials. ^{a)}Author to whom correspondence should be addressed: yyue@whu.edu.cn. Tel.: 86 27-68778876.

ABSTRACT Along with device miniaturization, severe heat accumulation at unexpected nanoscale hotspots attracts wide attentions and urges efficient thermal management. Heat convection is one of the important heat dissipating paths at nanoscale hotspots but its mechanism is still unclear. Here shows the first experimental investigation of the convective heat transfer coefficient at size-controllable nanoscale hotspots. erate hundreds of nanometers heating sources under laser irradiation and the graphene layer works as a temperature probe in Raman thermometry. The determined convective heat transfer coefficient (1928+155 -147 W m⁻² K⁻¹ for the 330 nm hotspot and 1793+157 $-159 \text{ Wm}^{-2} \text{ K}^{-1}$ for the 240 nm hotspot) is about three orders of magnitude higher than that of nature convection, when the simultaneous interfacial heat conduction and radiation are carefully evaluated. Heat convection, thus, accounts to more than half of the total energy transferred across the graphene/gold nanorods interface. Both the plasmon induced nanoscale hotspots and ballistic convection of air molecules contribute to the enhanced heat convection. This work reveals the importance of heat convection at nanoscale hotspots to the accurate thermal design of miniaturized electronics and further offers a new way to evaluate the convective heat transfer coefficient at nanoscale hotspots.

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I. INTRODUCTION

The increasing power density in condensed integrated circuits and transistors brings an urgent need to explore thermal dissipation mechanism in confined spaces.^{1,2} Besides mass heat accumulation, unexpected hotspots occurring at micro/nanostructures could strongly elevate local temperature and cause material deterioration and even device failure. When the characteristic length of these hotspots are at the scale of the surrounding media's phonon mean free path (MFP), the local thermal transport switches from the diffusion regime to the ballistic regime.³ Studies have shown the frequent occurrence of ballistic behavior of thermal transport at micro/nanoscale hotspots,⁴ which is greatly different from the macroscale heat transfer. Taking the ballistic heat conduction as an example, the effective thermal conductivity (κ) of the local media is obviously lower than its bulk value.⁵

Convection thermal transport plays a critical role in heat removal due to the existence of air surrounding the electronic devices.⁶ Studies have shown that the convection thermal transport of water flow at microscale differs from macroscale.⁷ However, as the dimension is down to the micro/nanoscale, reported results are scarce due to the measurement difficulties at such extreme scales.⁸ Raman thermometry is a well-established approach for small-scale

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temperature probing, in which temperature of the small scale could be accurately measured by evaluating the Raman shift of the characteristic Raman peaks of the local materials excited by Raman excitation laser. The focal diameter of the Raman excitation laser could be as small as 500 nm. For nano-materials and structures smaller than 500 nm having strong Raman scatterings could further increase the spatial resolution for temperature probing. These material-specific Raman peaks could also be captured using the same approach, such as 135 nm diameter porous silicon mem-brane and quantum dots.^{9,10} The utilization of high-resolution Raman thermometry could also obtain the temperature at nanoscale hotspots surrounded by air molecules.

In this work, a specially designed tip-patterned substrate under Raman laser irradiation is used to generate hotspots and Raman scatterings. Raman thermometry can be combined to create a tip-enhanced Raman thermometry for hotspots generation and measurements.¹¹ By using experimental and numerical approaches, a tip-enhanced Raman thermometry is created to directly measure the interface thermal conductance and convective heat transfer coefficient at nanoscale hotspots. A periodic Au nanorods array is fabricated and utilized as resupinate tips to create hotspots based on their plasmonic effect under laser irradiation.^{12,13} To be specific, the localized surface plasmon resonance of the gold nanorods under the 532 nm laser irradiation enhances the local electromagnetic field so as to the absorption in a single-layer graphene on the top of the nanorod. The heat transfer mechanism is then investigated in the

graphene supported to reveal the importance of ballistic transport enhanced heat convection at nanoscale hotspots.

II. EXPERIMENTAL DETAILS

A. Preparation of Au nanorod array

Template-assisted lithography is used to prepare a gold nanopattern on the silicon substrate. The procedures are shown in Fig. 1. A commercial ultrathin alumina membrane (UTAM) works as a template, which has multiple pores with a thickness of 650 nm, diameter of 350 nm, and periodicity of 450 nm. The polymethyl methacrylate (PMMA) is the support material.¹⁴ After being coated with a 200 nm gold coating and then peeled off the UTAM, the Au nanorods are fabricated in the masked substrate. On the rest uncovered silicon substrate, a continuous Au film (AuF) is simultaneously deposited.

Figure 2 shows structure characterization of the Au nanorods (Au330) on the silicon substrate. The nanorods have an average diameter of 330 nm, a height of 200 nm, and a periodicity of 450 nm. A CVD prepared single-layer graphene (Gr) with the dimension of 1×1 cm² is later transferred onto Au330/Si [Fig. 2(b)]. Compared with the close contact between graphene and gold sputter-coating film/silicon substrate (AuF/Si), the contact areas between graphene and Au330/Si are restricted to the top areas of the gold nanorods.

Another sample have the Au nanorods with a diameter of 240 nm on the silicon substrate (Au240/Si) is later fabricated. The



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FIG. 2. SEM images of (a) Au330/Si and (b) graphene on Au330/Si. (c) 3D AFM image of Au330/Si. (d) Longitudinal section analysis of the nanorod height for Au330 in accordance with the evaporation film thickness. (e) Histogram of diameter distribution for Au330.

preparation process of Au240/Si is similar as that of Au330/Si. The used UTAM has pores with a diameter of 260 nm, a periodicity of 450 nm, and a thickness of 650 nm. The thickness of the evaporated Au film is 100 nm. The SEM image in Fig. 3(a) shows that Au240 are patterned in a long-range hexagonal array. The average diameter of the nanorods is $240 \pm 26 \text{ nm}^2$ shown in Fig. 3(b), the periodicity of the nanorods is 450 nm, and the averaged height of the nanorods shown in Figs. 3(c) and 3(d) is in accordance with the evaporation film thickness. After the Au240/Si is prepared, a single-layer graphene is also transferred to both the top of the nanorods region and continous Au film region. SEM images of Gr/Au240/Si in Fig. 3(e) show a layer graphene suspended on the top surface of the Au240 array.

B. Measurements of temperature rise of graphene

Graphene has a strong Raman scattering and is a good candidate for temperature probing around the top of Au nanorods. Thus, a Raman spectrometer (B&W Tek) with a 532 nm diode laser is first used for temperature coefficient calibration of graphene Raman signal. The focusing laser spot has a diameter of ~50 μ m at the tested surface with a power of 30 mW. Temperature of the sample is precisely controlled by a ceramic heater over the range from 300 to 365 K. An integration time of 240 s is applied to ensure the temperature measurement accuracy. As shown in Fig. 4(a), the peak wavenumber is determined by fitting *G*-band using a single Lorentzian shape.¹⁵ The Raman signal of graphene is collected at least three times for averaging. All the experiments are repeated twice for averaging. The temperature coefficient calibration result is shown in Fig. 4(b). As the temperature increases, the peak wavenumber of the *G*-band shifts to a lower wavenumber. The temperature coefficient of the *G*-band is determined as -0.021 ± 0.005 cm⁻¹ K⁻¹, in good agreement with the reported value $(-0.025 \text{ cm}^{-1} \text{ K}^{-1})$.¹⁶

For temperature rise measurement of graphene on AuF/Si and Au330/Si, it is conducted using the same Raman spectrometer, but the incident Raman laser serves as the exciting and heating source simultaneously. The laser power per unit area is adjusted from 0.006 to 0.015 mW μ m⁻², while the integration time varies from 50 to 20 s to guarantee strong Raman signals. In Figs. 5(a) and 5(b), the *G-band* for both Gr/AuF/Si and Gr/Au330/Si shifts to left due to heating induced temperature rise. However, under the same heating level, the shift of the peak wavenumber of the *G-band* for two samples is different. After excluding the effect of the integration



FIG. 3. Au240/Si substrate characterization. (a) SEM image of Au240/Si. (b) Histogram of diameter distribution for Au240. The average diameter of the nanorods is 240 nm. They range in a hexagonal array with a periodicity of 450 nm. (c) 3D AFM image of Au240/Si. (d) Longitudinal section analysis of nanorods height for Au240, in

time, the obtained G-band is fitted to determine the graphene temperature. To alleviate the measurement uncertainties, the change in peak wavenumber against laser power is applied to extract the graphene temperature rise. The determined peak wavenumber shift against laser power for two samples is shown in Figs. 3(c) and 3(d). The average temperature rise per unit laser power is $1.38 \pm 0.62 \text{ K mW}^{-1}$ for Gr/AuF/Si and $3.52 \pm 1.01 \text{ K mW}^{-1}$ for Gr/Au330/Si. It is obviously that the temperature in Gr/Au330/Si is much higher than that in Gr/AuF/Si, when applying the same level heating power. The nanorods induced optical field enhancement and nanoscale heat transfer mechanism may account for this difference.

accordance with the evaporation film thickness. (e) SEM images of Gr/Au240/Si. (f) Raman spectrum of Gr/AuF/Si and Gr/Au240/Si.

III. RESULTS AND DISCUSSION

A. Electromagnetic field simulation of Au nanorod array

Under the irradiation of the laser with a wavelength in the visible range, the gold nanostructures could generate localized surface plasmons around the nanostructures and enhance the local electromagnetic field due to the localized surface plasmon resonance (LSPR). Therefore, the local optical field adjacent to the top of the nanorods will be enhanced, so as to the absorbed laser energy by the graphene attached to the top of those nanorods, when compared with the laser absorption of the graphene on AuF/Si. As shown in

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FIG. 4. (a) The typical *G*-band of graphene and its Lorentzian fitting line. (b) Calibration result of *G*-band. The inset depicts *G*-band line at temperatures ranging from 300 to 365 K.

Fig. 6, the finite-difference time-domain (FDTD) simulation is performed to define the LSPR-induced enhancement of the incident optical field. In the FDTD model, a hexagonal array of Au nanorods is used for representing the array of Au330. The nanorod has a diameter of 330 nm, a height of 200 nm, and the periodicity of cylinders is 450 nm, which are in accordance with the exact dimensions of the prepared Au330. A plane wave with the wavelength ranging from 400 to 800 nm comes from the top of the domain and is



FIG. 5. Raman based temperature measurement. The contour map of Raman peak for *G*-band vs laser power for (a) Gr/AuF/Si and (b) Gr/Au330/Si. Linear fitting of the *G*-band peak wavenumber against the laser power for (c) Gr/AuF/Si and (d) Gr/Au330/Si in the heating range from 12 to 30 mW.

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FIG. 6. Surface enhancement on the Au nanorods. (a) The simulated extinction spectrum of Au330. The electric intensity enhancement distribution (on a log scale) on (b) the top surface of gold nanorods and (d) the central *xz* plane at 532 nm laser excitation. (c) Comparison in Raman spectra of graphene on AuF/Si and Au330/Si. An enhancement factor of 11.8 is observed for the G peak of graphene on Au330/Si.

normal to the top of the rods. Its polarization direction is along the *x* axis. The computational domain is $900 \times 779 \times 2000 \text{ nm}^3$ ($x \times y \times z$). Periodic boundary conditions are applied to the *x*-*y* plane and perfectly matched layer boundary conditions are applied to the *z* direction. The distance from the nanorods to the absorbing boundary is set to be larger than one half of the incident wavelength. The entire domain is adaptively divided into cuboid elements with their side length less than 1/26 of the incident wavelength. For simplicity, the amplitude of the incident electric field (*E*₀) is set to be 1 V m⁻¹. The permittivities of gold are obtained from the reported data by Johnson and Christy.¹⁷ The calculated Raman enhancement factor is estimated as the second power of electric intensity enhancement factor based on the electromagnetic enhancement mechanism.¹⁸

To determine the absorption of incident energy (extinction, *A*) by the gold layer, reflection (*R*) and transmission (*T*) on the gold film are simulated. The extinction is calculated by A = 1 - R - T. The electric field intensity distribution around Au330 is also simulated by using the FDTD model described above. LSPR (localized surface plasmon resonance) generated by Au330 enhances the Raman intensity by a factor of 11.8 and 20.4 for the *G*-band and the 2D-band, respectively. The enhancement distribution induced by Au330 can

be pictured by the simulated electromagnetic field. The Au330 absorption [Fig. 6(a)] decreases from 0.8 to 0.04 as the incident wavelengths increasing from 400 to 800 nm with two plasmonic bands. Figures 6(b) and 6(d) show that the top surface electric field at the nanorod edge is greatly intensified generating theoretical Raman enhancement factor of 9.3 for the *G*-band at 532 nm.^{19,20}

B. Interfacial thermal conductance between Au and graphene

In addition to the LSPR-induced optical field enhancement, the substrate structure is another main factor contributing to this difference. Under the steady state laser heating, the generated thermal energy in the graphene layer then dissipates to the surroundings through heat conduction, convection, and radiation. The schematic experimental setup and heat transfer mechanism for Gr/AuF/Si and Gr/Au330/Si are shown in Fig. 7(a). The large heating spot size, which is larger than the phonon mean free path in graphene,²¹ ensures that the temperature in the spot region will be uniform. Theoretically, for Gr/AuF/Si [Fig. 7(b)], the main heat dissipation pathways are conducting along the in-plane direction in the graphene layer (q_{f1}) and across the Gr/Au interface



FIG. 7. Different heat transfer mechanisms in two structures. (a) The schematic of laser heating on Gr/AuF/Si and Gr/Au330/Si. Two different mechanisms of thermal transport in (b) Gr/AuF/Si and (c) Gr/Au330/Si under the laser heating.

 (q_{down1}) with some dissipation through thermal radiation (q_{rad1}) and convection (q_{con1}) from the top surface of the graphene layer. For Gr/Au330/Si, the thermal transport path is a little different. Since only a portion of the bottom surface of the graphene layer is contacted by Au330, the rest suspended portion is surrounded by air at both top and bottom surfaces shown in Fig. 7(c). Thus, heat convection and radiation will occur from both top surface and exposed bottom surface of the graphene layer. To investigate the convective thermal transport from graphene on Au330/Si, the thermal conduction across the Gr/Au interface must be studied first.

Given that Gr/AuF/Si and Gr/Au330/Si are prepared in the same batch, the roughness of the top surface for AuF and Au330 should be similar. Furthermore, Au330 have the same height as AuF has. They densely distribute on the Si substrate between two large gold films, so the transferred graphene layer could be well supported by Au330. We assume that the contact between the graphene layer and Au330 is in the same condition as that between graphene and AuF. Then, the interfacial thermal conductance ($G_{\rm Gr/Au}$) between the graphene layer and the Au film is measured first in Gr/AuF/Si.

Based on the experimentally measured temperature rise of graphene on AuF/Si, the interface thermal conductance can be solved with the assistance of the numerical finite element (FE) method. In

the FE model for Gr/AuF/Si in Fig. 8(a), a uniform heat generation source $\dot{q}_{\rm Gr1}$ is applied to the graphene for the reason that the heating spot is large enough and the temperature is uniform in the spot region. It has the expression as $\dot{q}_{\rm Gr1} = I\alpha_{\rm Gr/Au}/t_{\rm Gr}$, where *I* is the incident laser intensity (0.015 mW μ m⁻²), $\alpha_{\rm Gr/Au}$ is the absorption of graphene on Au film, and $t_{\rm Gr}$ is the thickness of the singlelayer graphene (~0.34 nm).²² The absorption of the suspended single-layer graphene is reported to be 2.3% in the visible light wavelength range.²³ However, in the case of the supported graphene, the incident laser will reflect at the interface between the graphene and the gold film. Given that 70% of the laser energy is reflected by Au film,²⁴ after transmitting through the supported graphene layer again, $\alpha_{\rm Gr/Au}$ is considered to be 3.9% in the FE model. The temperature of the surrounding boundary of graphene is kept at room temperature (300 K). Convective heat transfer from graphene to air is considered. Radiative heat transfer to surroundings from the graphene surface is negligible because it is estimated to be 0.002% of the total heat dissipation in graphene considering that the emissivity of graphene is 0.023 based on the Stefan-Boltzmann law. The constant pressure heat capacity and density of graphene is set as 750 J $(kg K)^{-1}$ and 2200 kg m^{-3.25} The thermal conductivity of graphene on the substrate $\kappa_{\rm Gr}$ is adopted as 179 W m⁻¹ K⁻¹. Though the thermal conductivity is large, the cross-sectional area



FIG. 8. (a) The schematic of the FE model for the determination of the interfacial thermal conductance ($G_{Gr/Au}$) between graphene and the Au film. (b) The schematic of the FE model for graphene on Au330/Si and the simulated temperature distribution of graphene on Au330/Si with the average temperature rise of graphene within the spot region as 105.7 K.

is small due to the atomic thickness of the single layer. Heat can pass through the interface to the Au/Si substrate and transfer to Au nanorods.

In the simulation, when the average temperature rise of graphene within the heating spot matches the experimentally result, the interface thermal conductance between the graphene and the gold film $G_{Gr/Au}$ is then determined to be 1.35+0.37 -0.33 × 10⁴ W m⁻² K⁻¹. This value is the same as that of the unconstrained graphene/4H SiC interface²⁷ but is much lower than that reported for the intercalated graphene interface.²⁸ It indicates the existence of a gap between graphene and AuF/Si. Molecular dynamics simulations also confirm that the conductance decreases exponentially with increasing gap thickness. This separation weakens the interatomic forces and energy coupling between the two materials. Ripples and wrinkles in graphene as well as chemical residues introduced during the preparation process will be the main cause of interfacial separation. In addition, the different thermal expansion behavior of graphene and gold may cause thermal mismatch²⁷ at the interface and further increase their separation distance. We evaluate the effect of the reference thermal conductivity of the graphene κ_{Gr} on the determined $G_{Gr/Au}$. It is found that the variation of $G_{Gr/Au}$ $(0.15 \text{ W m}^{-2} \text{ K}^{-1})$ raised by κ_{Gr} is much less than the uncertainty of $G_{\rm Gr/Au}$ in the temperature measurement of graphene, when $\kappa_{\rm Gr}$ varies from 179 to 600 W m⁻¹ K⁻¹.²⁹

C. Convective heat transfer coefficient at graphene nanoscale hotspot

The surface temperature of graphene on Au330/Si is measured using the same Raman method and its Raman intensity contour map against incident power is shown in Fig. 5(b). Combined with the temperature coefficient of *G-band* Raman shift ($-0.021 \text{ cm}^{-1} \text{ K}^{-1}$), the temperature rise of graphene is determined by the slope of the fit of the *G-band* Raman shift to the laser power ($-0.074 \text{ cm}^{-1} \text{ mW}^{-1}$), as shown in Fig. 5(d). The average local temperature rise within the laser irradiated region is $105.7 \pm 2.4 \text{ K}$ at a laser power of 30 mW, which is much higher than $41.4 \pm 9.5 \text{ K}$ for graphene on AuF/Si, indicating that graphene is additionally heated by the Au330-induced hotspots. For the graphene on Au330/Si, the contact area of the graphene/ Au330 interface is reduced due to the discontinuity of the upper surface of the Au330 layer, and the generated heat can only be conducted through the contact area. The low thermal conductance at the loosely contacted interface limits the heat dissipation and raises the temperature of the graphene layer. By improving the photon absorption in graphene, the confined electric field in the local region around the nanorods provides an opportunity to generate nanoscale hotspots in graphene.

The schematic of the simulation model for graphene on Au330/Si is shown in Fig. 8(b). A uniform heat generation $\dot{q}_{\rm Gr2}$ is applied in graphene within the laser irradiated area, which is expressed as $\dot{q}_{\rm Gr2} = I\alpha_{\rm Gr}M/t_{\rm Gr}$, where $\alpha_{\rm Gr}$ is the absorptance of single-layer graphene, 2.3%. *M* is the calculated electric intensity enhancement factor, M = 3.1. *I* is the incident laser intensity (0.015 mW μ m⁻²). The temperature of surrounding boundary is set as room temperature. Thermal convection conditions are used on the top surface and the bottom suspended region of graphene. The radiative heat loss is around 0.002%-0.003% of the total heat dissipation of graphene and is still neglected in this model. When the average temperature rise of the graphene within the laser spot matches the experimental result, the convective heat transfer coefficient (*h*) around graphene nanoscale hotspot on gold nanopattern is determined to be 1928+155 -147 W m⁻² K⁻¹. The percentage of the convective heat loss around the graphene for Gr/Au330/Si is then calculated to be about 26.6%. High heat convection effect and low interfacial thermal conductance prevent large amount of thermal energy from conducting to the Au nanorod substrates.

D. Parallel measurement on Au240

The hotspots generated by the LSPR effect correspond to the size of the nanorods. In thermal measurement, nanorods work as nanoheaters that heat the graphene layer and some of the heat dissipates into the air molecules surrounding the nanorods. When the size of nanoheaters is close to the mean free path of air molecules at room temperature and pressure, the size effect will enhance the convective heat transfer coefficient *h* by several orders of magnitude.⁷ To confirm this speculation, we use the other gold-nanorod pattern

(Au240), whose nanorods have a diameter of 240 nm, a height of 100 nm, and a period of 450 nm, in accordance with Au330.

Raman spectrum of Gr/Au240/Si in Fig. 3(f) illustrates the *G-band* around 1589.86–1593.39 cm⁻¹ and 2*D-band* around 2682.67–2686.23 cm⁻¹.³⁰ The absence of *D* band indicates few defects in transferred graphene on Au240/Si. The ratio I_{2D}/I_G is 1.28, indicating the nature of the monolayer.¹⁵ *G-band* exhibits an upshift of 5 cm⁻¹ with respect to graphene on AuF/Si due to the doping effect. The downshift of 2*D-band* of graphene on Au240 may be attributed to the doping of graphene by the Au nanorods and compressive strain.^{31–33}

As shown in Fig. 3(f), the Raman intensity of G-band and 2D-band of graphene on Au240/Si is enhanced by a factor of 3.3 and 5.7, respectively. This enhancement factor is comparable to the literature-reported value for 140-210 nm Au dots.³⁴ The simulated extinction spectrum in Fig. 9(a) of Au240 exhibits plasmon bands in the range of 400-800 nm with the peak wavelengths at 432 and 536 nm. It agrees well with the measured results of gold nanoparticles with the similar size,³⁵ confirming the existence of the plasmonic effect of the Au nanorods.^{19,20,34} The simulated electric field around Au240 shown in Figs. 9(b) and 9(d) illustrates that the enhanced electric field occurs at the edges on the top surface of Au240 and is confined in 10 nm scale along the x axis and 80 nm along the y axis. The region of electromagnetic field enhancement is more obvious and larger than that of Au330 in Fig. 6(d). Based on the mechanism of electromagnetic enhancement for surface enhanced Raman scattering,³⁶ the theoretical Raman enhancement factor of graphene induced by Au240 is calculated to be 3.0 at 532 nm, well agreeing with the experimental value.^{19,20} The extremely concentrated electric field contributed a lot to the energy absorption in the graphene layer in sample Gr/Au330/Si, while the less concentrated electric field in Gr/Au240/Si may be the main reason causing lower electric field intensity.

Raman thermal measurement has been conducted on Gr/Au240/Si by varying the laser power under the excitation of the 532 nm diode laser. As shown in Fig. 9(c), the *G*-band wavenumber shifts linearly with the increment of the laser power. The fitted slope is -0.057 ± 0.009 cm⁻¹ mW⁻¹. The local average temperature rise of graphene within the focal spot is 81.4 ± 3.8 K at 30 mW. The less concentrated electric field also causes a lower temperature rise in the 0.34 nm thick graphene layer in Gr/Au240/Si. The determined convective heat transfer coefficient (*h*) around the graphene on Au240/Si is 1793+157 -159 W m⁻² K⁻¹. Considering the little geometric differences and measurement uncertainties,^{28,37} this result is consistent with measured value of Gr/Au330/Si.

E. Combination of nanoscale heating and ballistic effect

The combination of LSPR-induced nanoscale hotspot heating and ballistic convection effect of air molecules may be responsible for the high values of the measured convective heat transfer coefficients. The nanoscale hotspot puts air convection in transition regime and transfers heat in a ballistic manner. The heat transfer government of the surrounding air molecules over the nanostructure-induced hotspots can be defined by *Kn* number, which is the ratio of the mean free path λ of air molecules³⁸ to the characteristic length of the hotspot. In the case of open-air measurements of Gr/Au330/Si, λ of air molecules is 80 nm and the *l* of gold nanorods is 330 nm. The resultant *Kn* is 0.24, which lies in the range of 0.01–10, indicating that the airflow regime over the hotspot belongs to the transition regime. Since



FIG. 9. (a) The simulated extinction spectrum of gold nanorods. The electric intensity enhancement distribution of (b) the top surface of gold nanorods and (d) the central *xz* plane. (c) Raman shift of the *G*-band vs laser power for Gr/A240/Si. The inset depicts *G*-band lines over the range of laser power from 12 to 30 mW.

the size of the hotspot is similar to the mean free path of air molecules, the probability of ballistic heat conduction of free air molecules may increase. Heat conduction through air molecules plays an important role instead of advection-based heat transfer,³⁷ leading to enhanced thermal convection.

The evaluation of heat dissipation based on the determined heat transfer coefficients demonstrates that convective heat loss accounts for 53%–100% of the total heat conduction from graphene to Au330/Si and Au240/Si through the interface. This high percentage indicates that the convective heat loss from the nanoscale hotspots in the graphene layers to the surrounding air is significant and cannot be neglected in the precise design of relevant thermal management systems. Meanwhile, the tip-enhanced Raman thermometry developed in this work offers a new methodology for measuring the convective heat transfer coefficient of the nanoscale hotspots.

IV. CONCLUSION

In summary, the convective heat transfer coefficient of air molecules in the transition regime over the nanoscale hotspot is characterized using the tip-enhanced Raman thermometry. The experimental results show that the gold-nanorod-induced nearfield effect (LSPR) enhances the Raman intensity and incident energy absorption, resulting in an LSPR-induced hotspot at the graphene layer. The temperature increase in the graphene layer is measured and used to reconstruct the heat transfer model in the sample and to determine the convective heat transfer coefficient over the hotspots. The determined average convective heat transfer coefficients, $1928+155 -147 \text{ Wm}^{-2} \text{ K}^{-1}$ for Gr/Au330 and 1793+157 $-159 \text{ Wm}^{-2} \text{ K}^{-1}$ for Gr/Au240, indicate ballistic driven large convective heat transfer at the nanoscale hotspot. This tip-enhanced Raman thermometry provides a new method to experimentally quantify ballistic heat transport from nanoscale hotspots. The measurement results can be used as a guide for better thermal design and management.

ACKNOWLEDGMENTS

The authors acknowledge the financial support from the National Key Research and Development Program (No. 2023YFE0120200), National Natural Science Foundation of China (NNSFC) (Nos. 52076156 and 52106220), and Science Fund for Distinguished Young Scholars of Hubei Province (No. 2022CFA076).

AUTHOR DECLARATIONS

Conflict of Interest

The authors have no conflicts to disclose.

Author Contributions

Shen Xu: Funding acquisition (equal); Investigation (equal); Methodology (equal); Visualization (equal); Writing – original draft (equal). Yanru Xu: Conceptualization (equal); Investigation (equal); Methodology (equal); Visualization (equal); Writing – original draft (equal). Jingchao Zhang: Investigation (equal); Methodology (equal); Writing – original draft (equal). Jianshu Gao: Visualization (equal); Writing – original draft (equal). Xinwei Wang: Writing – review & editing (supporting). Xin Zhang: Writing – review & editing (equal). Yanan Yue: Conceptualization (equal); Funding acquisition (equal); Investigation (equal); Methodology (equal); Supervision (lead); Writing – review & editing (equal).

DATA AVAILABILITY

The data that support the findings of this study are available within the article.

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